



1 CHANNEL HIGH SURGE TVS DIODE

Product Summary

V _{BR (min)}	PP (max)	I _{R (max)}
22V	120A	200nA

Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in portable applications such as cellular phones, digital cameras, and MP3 players.

Applications

- Cellular Handsets
- Portable Electronics
- Computers and Peripheral

Features

- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±30kV, Contact ±30kV
- One Channels of ESD Protection
- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: U-DFN2020-2
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 <a> § ¶
- Weight: 0.004 grams (Approximate)



Device Schematic

Ordering Information (Note 4)

Product	Comp	liance Mark	ring Reel Size (i	nches) Tape Width	(mm) Quantity per Reel
D20V0S1U2LP	20-7 Stan	dard 6k	7	8	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

Marking Information



6K = Product Type Marking Code YM = Date Code Marking Y = Year (ex: B = 2014) M = Month (ex: 9 = September) Dot = Cathode



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P_PP	4400	W	8/20µs (Note 7)
Peak Pulse Current	I _{PP}	120	Α	8/20μs (Note 7)
ESD Protection - Contact Discharge	V _{ESD_Contact}	±30	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V_{ESD_Air}	±30	kV	Standard IEC 61000-4-2

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_{D}	500	mW
Thermal Resistance, Junction to Ambient T _A = +25°C	Reja	250	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V_{RWM}			20	V	_
Channel Leakage Current (Note 6)	I_{R}		_	200	nA	$V_R = 20V$
Forward Voltage	V_{F}	0.6	0.8	1.2	V	$I_R = 10mA$
Reverse Breakdown Voltage	V_{BR}	22	_	_	V	$I_R = 1mA$
		_	_	26.5	V	$I_{PP} = 1A$, $t_p = 8/20 \mu s$
Clamping Voltage, Positive Transients (Note 7)	V _C	_	_	28.0	V	$I_{PP} = 10A$, $t_p = 8/20 \mu s$
		_	_	37.0	V	$I_{PP} = 120A$, $t_p = 8/20\mu s$
Channel Input Capacitance (Note 8)	Ст	_	880	_	pF	$V_R = 0V$, $f = 1MHz$

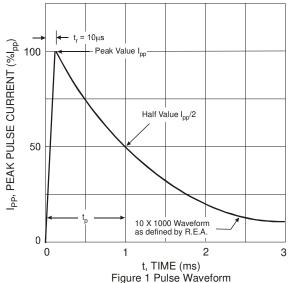
Notes:

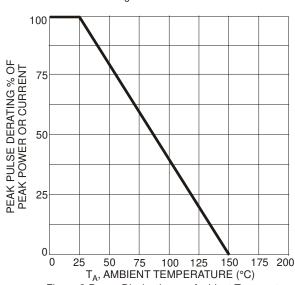
- 5. Device mounted on FR-4 PCB pad layout (2oz copper), which can be found at http://www.diodes.com/package-outlines.html.
- 6. Short duration pulse test used to minimize self-heating effect.

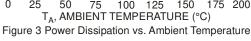
 7. Clamping voltage value is based on an 8 × 20µs peak pulse current (I_{pp}) waveform.
- 8. Measured from any I/O to GND.
- Weasured find any for GAD.
 By For information on the impact of Diodes' USB 2.0 compatible ESD protectors on signal integrity including eye diagram plots, please refer to https://www.diodes.com/assets/App-Note-Files/AN77.pdf.

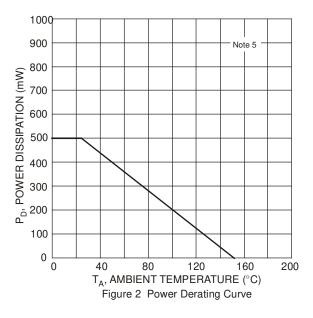


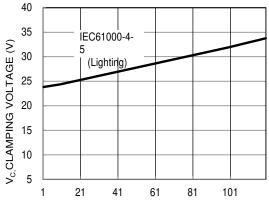




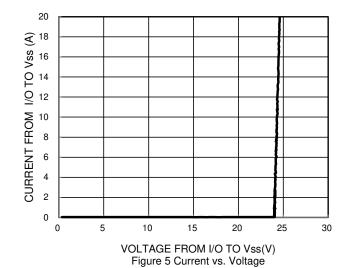








CURRENT FROM I/O TO $V_{SS}(A)$ Figure 4 Clamping Voltage Characteristic

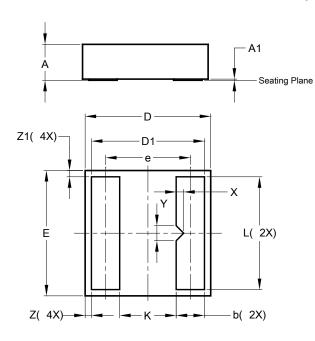




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-2

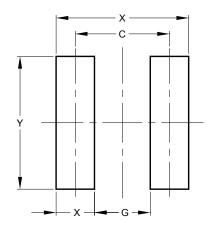


	U-DFN2020-2				
Dim	Min	Max	Тур		
Α	0.545	0.605	0.575		
A1	0	0.05	0.02		
b	0.35	0.55	0.45		
D	1.90	2.10	2.00		
D1	1.70	1.90	1.80		
Е	1.90	2.10	2.00		
е	1.35 BSC				
K	0.80	1.00	0.90		
L	1.70	1.90	1.80		
X	-	-	0.120		
Υ	-	-	0.240		
Z	0.10 BSC				
Z 1	0.10 BSC				
Al	All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-2



Dimensions	Value (in mm)
С	1.350
G	0.800
Х	0.550
X1	1.900
Υ	1.900



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